

NTMFS4955NT1G Datasheet

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DiGi Electronics Part Number	NTMFS4955NT1G-DG
Manufacturer	onsemi
Aanufacturer Product Number	NTMFS4955NT1G
Description	MOSFET N-CH 30V 9.7A/48A 5DFN
Detailed Description	N-Channel 30 V 9.7A (Ta), 48A (Tc) 920mW (Ta), 23 .2W (Tc) Surface Mount 5-DFN (5x6) (8-SOFL)

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Purchase and inquiry

Manufacturer Product Number:	Manufacturer:
NTMFS4955NT1G	onsemi
Series:	Product Status:
-	Obsolete
FET Type:	Technology:
N-Channel	MOSFET (Metal Oxide)
Drain to Source Voltage (Vdss):	Current - Continuous Drain (Id) @ 25°C:
30 V	9.7A (Ta), 48A (Tc)
Drive Voltage (Max Rds On, Min Rds On):	Rds On (Max) @ ld, Vgs:
4.5V, 10V	6mOhm @ 30A, 10V
Vgs(th) (Max) @ ld:	Gate Charge (Qg) (Max) @ Vgs:
2.2V @ 250µA	10.8 nC @ 4.5 V
Vgs (Max):	Input Capacitance (Ciss) (Max) @ Vds:
±20V	1264 pF @ 15 V
FET Feature:	Power Dissipation (Max):
-	920mW (Ta), 23.2W (Tc)
Operating Temperature:	Mounting Type:
-55°C ~ 150°C (TJ)	Surface Mount
Supplier Device Package:	Package / Case:
5-DFN (5x6) (8-SOFL)	8-PowerTDFN, 5 Leads
Base Product Number:	
NTMFS4955	

Environmental & Export classification

RoHS Status:	Moisture Sensitivity Level (MSL):
ROHS3 Compliant	1 (Unlimited)
REACH Status:	ECCN:
REACH Unaffected	EAR99
HTSUS:	
8541.29.0095	

MOSFET – Power, Single, N-Channel, SO-8 FL 30 V, 48 A

Features

- Low RDS(on) to Minimize Conduction Losses
- Low Capacitance to Minimize Driver Losses
- Optimized Gate Charge to Minimize Switching Losses
- Optimized for 5 V, 12 V Gate Drives
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

Applications

- CPU Power Delivery
- DC-DC Converters

MAXIMUM RATINGS (T_J = 25° C unless otherwise stated)

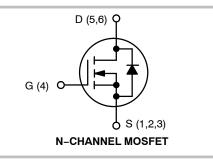
Para	meter		Symbol	Value	Unit
Drain-to-Source Volt	age		V _{DSS}	30	V
Gate-to-Source Volta	age		V _{GS}	±20	V
Continuous Drain Current R $_{\theta JA}$		$T_A = 25^{\circ}C$	I _D	16.7	Α
(Note 1)		$T_A = 100^{\circ}C$		10.5	
Power Dissipation $R_{\theta JA}$ (Note 1)		$T_A = 25^{\circ}C$	PD	2.70	W
Continuous Drain		$T_A = 25^{\circ}C$	Ι _D	25.2	А
Current $R_{\theta JA} \le 10 \text{ s}$ (Note 1)		T _A = 100°C		15.9	
Power Dissipation $R_{\theta JA} \leq 10 \text{ s} \text{ (Note 1)}$	Steady State	T _A = 25°C	PD	6.16	W
Continuous Drain Current R _{0.IA}		T _A = 25°C	Ι _D	9.7	А
(Note 2)		T _A = 100°C		6.2	
Power Dissipation $R_{\theta JA}$ (Note 2)		T _A = 25°C	PD	0.92	W
Continuous Drain		$T_{C} = 25^{\circ}C$	Ι _D	48	А
Current R _{θJC} (Note 1)		T _C =100°C		30	
Power Dissipation $R_{\theta JC}$ (Note 1)		T _C = 25°C	P _D	23.2	W
Pulsed Drain Current	T _A = 25°	² C, t _p = 10 μs	I _{DM}	210	A
Current Limited by Pa	ackage	T _A = 25°C	I _{Dmax}	100	Α
Operating Junction ar Temperature	nd Storage	•	T _J , T _{STG}	–55 to +150	°C
Source Current (Body			ا _S	21	Α
Drain to Source DV/D	T		dV/d _t	6.0	V/ns

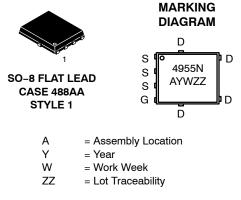


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V _{(BR)DSS}	R _{DS(ON)} MAX	I _D MAX
30 V	5.6 m Ω @ 10 V	48 A
50 V	8.5 mΩ @ 4.5 V	40 A





ORDERING INFORMATION

Device	Package	Shipping [†]
NTMFS4955NT1G	SO-8 FL (Pb-Free)	1500 / Tape & Reel
NTMFS4955NT3G	SO-8 FL (Pb-Free)	5000 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

MAXIMUM RATINGS (T_J = 25°C unless otherwise stated)

Parameter	Symbol	Value	Unit
Single Pulse Drain-to-Source Avalanche Energy (T _J = 25°C, V _{DD} = 24 V, V _{GS} = 10 V, I _L = 26 A _{pk} , L = 0.1 mH, R _G = 25 Ω)	E _{AS}	34	mJ
Lead Temperature for Soldering Purposes (1/8" from case for 10 s)	ΤL	260	°C

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Surface-mounted on FR4 board using 1 sq-in pad, 1 oz Cu.
Surface-mounted on FR4 board using the minimum recommended pad size.

THERMAL RESISTANCE MAXIMUM RATINGS

Parameter	Symbol	Value	Unit
Junction-to-Case (Drain)	$R_{ extsf{ heta}JC}$	5.4	
Junction-to-Ambient - Steady State (Note 3)	R_{\thetaJA}	46.3	°C/W
Junction-to-Ambient - Steady State (Note 4)	R_{\thetaJA}	136.2	°C/W
Junction-to-Ambient – (t \leq 10 s) (Note 3)	$R_{ hetaJA}$	20.3	

Surface-mounted on FR4 board using 1 sq-in pad, 1 oz Cu.
Surface-mounted on FR4 board using the minimum recommended pad size.

ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise specified)

Parameter	Symbol	Test Condition		Min	Тур	Max	Unit
OFF CHARACTERISTICS							
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	V_{GS} = 0 V, I_D = 250 μ A		30			V
Drain-to-Source Breakdown Voltage (transient)	V _{(BR)DSSt}	V_{GS} = 0 V, $I_{D(aval)}$ = 11.0 A, T _{case} = 25°C, t _{transient} = 100 ns		34			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V _{(BR)DSS} / T _J				21		mV/°C
Zero Gate Voltage Drain Current	I _{DSS}	$V_{GS} = 0 V,$	$T_J = 25^{\circ}C$			1.0	
		V _{DS} = 24 V	T _J = 125°C			10	μΑ
Gate-to-Source Leakage Current	I _{GSS}	V_{DS} = 0 V, V_{GS}	= ±20 V			±100	nA

ON CHARACTERISTICS (Note 5)

Gate Threshold Voltage	V _{GS(TH)}	$V_{GS} = V_{DS}, I_D = 250 \ \mu A$		1.2	1.7	2.2	V
Negative Threshold Temperature Coefficient	V _{GS(TH)} /T _J				3.9		mV/°C
Drain-to-Source On Resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 30 A		4.5	5.6	
			I _D = 15 A		4.5		
		V _{GS} = 4.5 V	I _D = 30 A		6.8	8.5	mΩ
			I _D = 15 A		6.7		
Forward Transconductance	9fs	V _{DS} = 1.5 V, I _D) = 15 A		52		S

CHARGES, CAPACITANCES & GATE RESISTANCE

Input Capacitance	C _{ISS}		1264		
Output Capacitance	C _{OSS}	V_{GS} = 0 V, f = 1 MHz, V_{DS} = 15 V	483		pF
Reverse Transfer Capacitance	C _{RSS}		143		
Capacitance Ratio	C _{RSS} / C _{ISS}	V _{GS} = 0 V, V _{DS} = 15 V, f = 1 MHz	0.11	0.22	

5. Pulse Test: pulse width \leq 300 $\mu s,$ duty cycle \leq 2%.

Switching characteristics are independent of operating junction temperatures.

NTMFS4955NT1G onsemi MOSFET N-CH 30V 9.7A/48A 5DFN

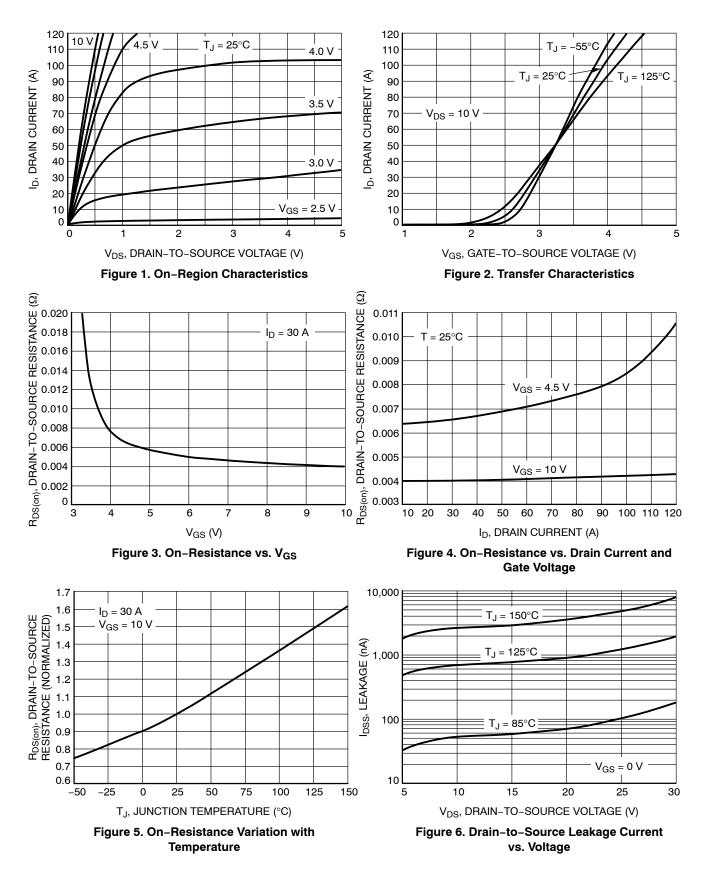
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ELECTRICAL CHARACTERISTICS (T_J = 25° C unless otherwise specified)

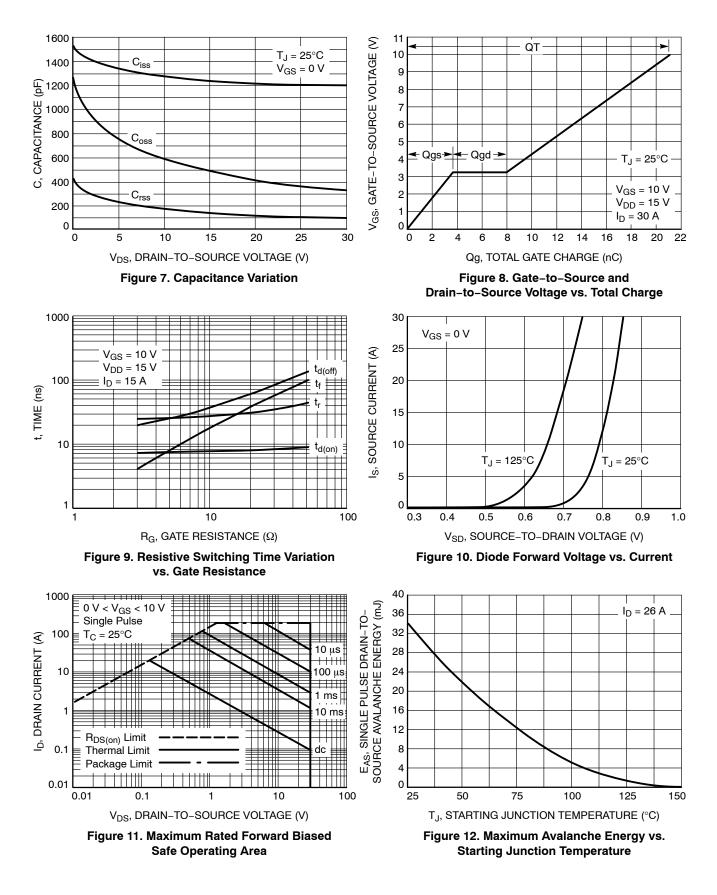
Parameter	Symbol	Test Cond	dition	Min	Тур	Max	Unit
CHARGES, CAPACITANCES & GAT	E RESISTANCE						
Total Gate Charge	Q _{G(TOT)}				10.8		
Threshold Gate Charge	Q _{G(TH)}				2.0		0
Gate-to-Source Charge	Q _{GS}	V _{GS} = 4.5 V, V _{DS} =	15 V; I _D = 30 A		3.8		nC
Gate-to-Drain Charge	Q _{GD}				4.2		
Total Gate Charge	Q _{G(TOT)}	V_{GS} = 10 V, V_{DS} =	15 V; I _D = 30 A		21.5		nC
SWITCHING CHARACTERISTICS (N	ote 6)	-					
Turn-On Delay Time	t _{d(ON)}				9.5		
Rise Time	t _r	V_{GS} = 4.5 V, V_{DS} = 15 V, I_D = 15 A, R_G = 3.0 Ω			32.7		
Turn-Off Delay Time	t _{d(OFF)}				16.4		ns
Fall Time	t _f				6.2		
Turn-On Delay Time	t _{d(ON)}	V _{GS} = 10 V, V _{DS} = 15 V, I _D = 15 A, R _G = 3.0 Ω			7.4		-
Rise Time	t _r				27.5		
Turn-Off Delay Time	t _{d(OFF)}				20.3		ns
Fall Time	t _f				4.1		1
DRAIN-SOURCE DIODE CHARACT	ERISTICS						
Forward Diode Voltage	V _{SD}	V _{GS} = 0 V,	$T_J = 25^{\circ}C$		0.86	1.1	
		$I_{\rm S} = 30$ Å	T _J = 125°C		0.75		V
Reverse Recovery Time	t _{RR}				25.8		
Charge Time	t _a	V _{GS} = 0 V. dIS/dt	: = 100 A/us.		12.4		ns
Discharge Time	t _b	$V_{GS} = 0 \text{ V, dIS/dt}$ $I_S = 30$	A		13.4		
Reverse Recovery Charge	Q _{RR}				13.6		nC
PACKAGE PARASITIC VALUES							
Source Inductance	L _S				1.00		nH
Drain Inductance	L _D	1	^		0.005		nH
Gate Inductance	L _G	T _A = 25	°C		1.84		nH
Gate Resistance	R _G	1			1.0	2.2	Ω

Pulse Test: pulse width ≤ 300 μs, duty cycle ≤ 2%.
Switching characteristics are independent of operating junction temperatures.

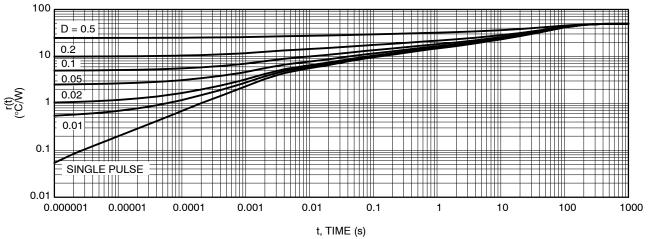
TYPICAL CHARACTERISTICS

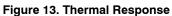


TYPICAL CHARACTERISTICS

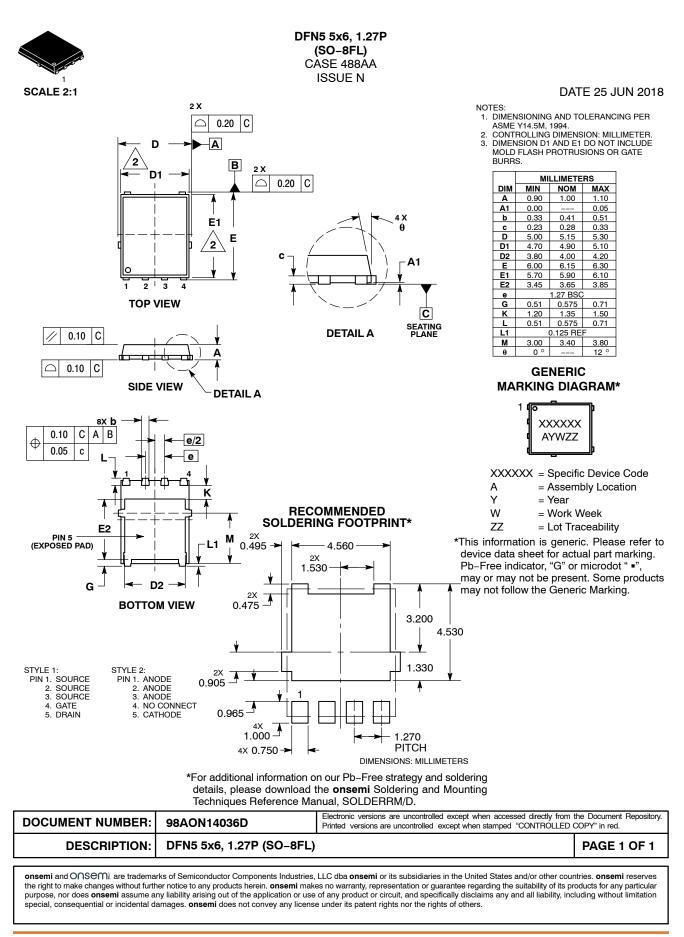


TYPICAL CHARACTERISTICS









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